

AST-4Q2FSF42LC1

400G-FR4 2km QSFP-DD Transceiver

Product Features

- Compliant with 400GBASE-FR4(IEEE802.3cu)
- Compliant with IEEE 802.3bs standard:
400GAUI-8 electrical interface
- Compliant with QSFP-DD MSA HW Rev5.1;
type 2 housing with duplex LC connector
- Compliant with QSFP-DD CMIS Rev 5.0
- Maximum power consumption 10 W
- Case operating temperature 0°C to 70°C
- Two wire serial Interface with digital diagnostic monitoring
- Complies with EU Directive 2011/65/EU
(RoHS compliant)
- Class 1 Laser

Module Characteristics

Table 1 – Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Storage Temperature	T _s	-40	+85	°C	
Supply Voltage	V _{cc}	-0.5	3.6	V	
Relative Humidity (non-condensing)	RH	5	95	%	
Data Input Voltage Differential	IV _{DIP} -V _{DINL}	-	1	V	
Control Input Voltage	V _I	-0.3	V _{cc} +0.5	V	
Control Output Current	I _o	-20	20	mA	

Table 2 – Recommended Operating Conditions

Parameter	Symbol	Min	Typical	Max	Unit	
Operating Case Temperature	T _{OPR}	0		70	°C	
Power Supply Voltage	V _{CC}	3.135	3.3	3.465	V	
Instantaneous peak current at hot plug	I _{CC_IP}	-	-	4000	mA	
Sustained peak current at hot plug	I _{CC_SP}	-	-	3300	mA	
Maximum Power Dissipation	P _D	-	-	10	W	
Maximum Power Dissipation, Low Power Mode	P _{DLP}	-	-	1.5	W	
Signalling Rate per Lane	SRL	-	53.125	-	Gbd	PAM4
Two Wire Serial Interface Clock Rate	-	-	-	400	kHz	
Module sinusoidal power supply noise tolerance 1kHz - 1MHz (p-p)	-	-	-	66	mV	
Rx Differential Data Output Load	-	-	100	-	Ohm	
Operating Distance	-	2	-	2000	m	

Functional Characteristics (Optical)

The following tables list the performance specifications for the various functional blocks of the integrated optical transceiver module.

Table 3 – Transmitter Optical Specifications

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Wavelength L0	λ_{C0}	1264.5	1271	1277.5	nm	
Wavelength L1	λ_{C1}	1284.5	1291	1297.5	nm	
Wavelength L2	λ_{C2}	1304.5	1311	1317.5	nm	
Wavelength L3	λ_{C3}	1324.5	1331	1337.5	nm	
Side Mode Suppression Ratio	SMSR	30	-	-	dB	
Average Launch Power, each lane	AOP _L	-3.2	-	4.4	dBm	1
Outer Optical Modulation Amplitude (OMA _{outer}), each lane	T _{OMA}	-	-	3.7	dBm	
Outer Optical Modulation Amplitude (OMA _{outer}), each lane: for TDECQ < 1.4dB for 1.4dB ≤ TDECQ ≤ 3.4dB	T _{OMA}	-0.2 -1.6+TDECQ	-	-		
Difference in launch power between any two lanes(OMA _{outer})	DP	-	-	3.9	dB	

Transmitter and Dispersion Eye Closure for PAM4 (TDECQ), each lane	TDECQ	-	-	3.4	dB	
Transmitter eye closure for PAM4(TECQ)	TECQ			3.4	dB	
TDECQ – TECQ	-	-	-	2.5	dB	
Over/under-shoot				22	%	
Transmitter power excursion				1.8	dBm	
Average Launch Power of OFF Transmitter, each lane	T _{OFF}	-	-	-16	dBm	
Extinction Ratio, each lane	ER	3.5	-	-	dB	
Transmitter transition time	-	-	-	17	ps	
RIN _{17.1OMA}	RIN	-	-	-136	dB/Hz	
Optical Return Loss Tolerance	ORL	-	-	17.1	dB	
Transmitter Reflectance	T _R	-	-	-26	dB	

Note 1: Average launch power, each lane (min) is informative and not the principal indicator of signal strength

Table 4 – Receiver Optical Specifications

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Wavelength L0	λ_{C0}	1264.5	1271	1277.5	nm	
Wavelength L1	λ_{C1}	1284.5	1291	1297.5	nm	
Wavelength L2	λ_{C2}	1304.5	1311	1317.5	nm	
Wavelength L3	λ_{C3}	1324.5	1331	1337.5	nm	
Damage Threshold, each lane	AOP _D	5.4	-	-	dBm	
Average Receive Power, each lane	AOP _R	-7.2	-	4.4	dBm	1
Receive Power (OMA _{outer}), each lane	OMA _R	-	-	3.7	dBm	
Difference in receive power between any two lanes (OMA _{outer})	DR			4.1	dB	
Receiver Reflectance	RR	-	-	-26	dB	
Receiver Sensitivity (OMA _{outer}), each lane for TDECQ < 1.4dB for 1.4dB ≤ TDECQ ≤ 3.4dB	S _{OMA}	-	-	-4.6 -6+TDECQ	dBm	
Stressed Receiver Sensitivity (OMA _{outer}), each lane	SRS	-	-	-2.6	dBm	
Conditions of stressed receiver sensitivity test						
Stressed eye closure for PAM4 (SECQ)			3.4		dB	
OMA _{outer} of each aggressor lane			1.4		dBm	

Note 1: Average receive power, (min) is informative and not the principal indicator of signal strength

Functional Characteristics (Electrical)

Table 5 – Electrical Specification High Speed Signal (compliant with IEEE 802.3bs 400GAUI-8)

Receiver (Module Output)						
Parameter	Symbol	Min	Typical	Max	Unit	Notes
AC common-mode output Voltage (RMS)		-	-	17.5	mV	
Differential output Voltage		-	-	900	mV	
Near-end Eye height, differential		70	-	-	mV	
Far-end Eye height, differential		30	-	-	mV	
Far end pre-cursor ISI ratio		-4.5	-	2.5	%	
Differential Termination Mismatch		-	-	10	%	
Transition Time (min, 20% to 80%)		9.5	-	-	ps	
DC common mode Voltage		-350	-	2850	mV	
Transmitter (Module Input)						
Parameter	Symbol	Min	Typical	Max	Unit	Notes
Differential pk-pk input Voltage tolerance		900	-	-	mV	
Differential termination mismatch		-	-	10	%	
Single-ended voltage tolerance range		-0.4	-	3.3	V	
DC common mode Voltage		-350	-	2850	mV	

Table 6 – Electrical Specification Low Speed Signal (compliant with QSFP-DD HW Rev 5.1)

Parameter	Symbol	Min	Max	Unit	Condition
Module output SCL and SDA	V _{OL}	0	0.4	V	
Module Input SCL and SDA	V _{IL}	-0.3	V _{CC} *0.3	V	
	V _{IH}	V _{CC} *0.7	V _{CC} +0.5	V	
InitMode, ResetL and ModSelL	V _{IL}	-0.3	0.8	V	
	V _{IH}	2	V _{CC} +0.3	V	
IntL	V _{OL}	0	0.4	V	

	V _{OH}	V _{CC-0.5}	V _{CC+0.3}	V	
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Pin Descriptions

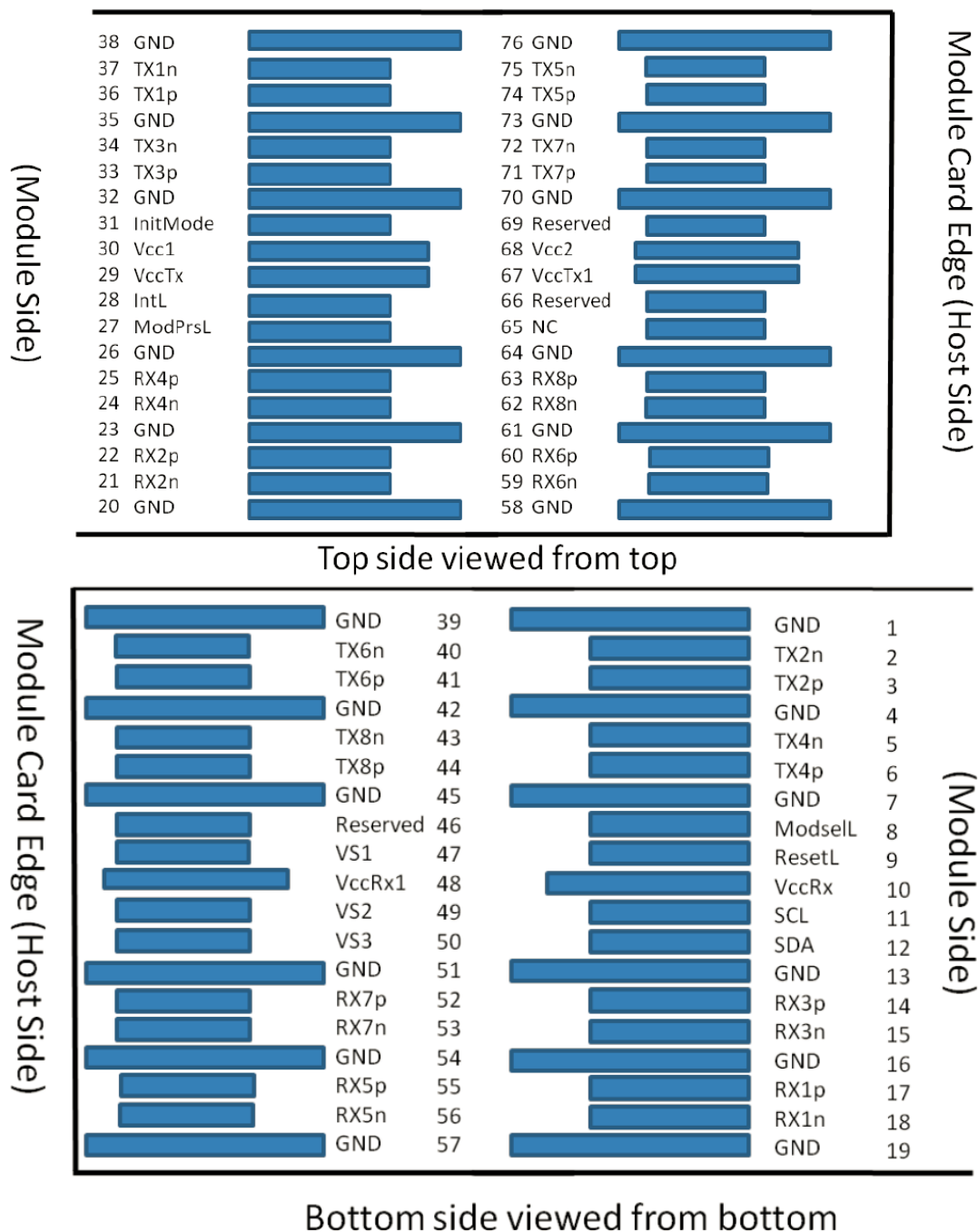


Figure 1 – Pin definitions of the module high speed inputs/outputs

Table 7 – Module Pin Definitions

PIN	Logic	Symbol	Definition	PIN	Logic	Symbol	Definition
1		GND	Ground	39		GND	Ground
2	CML-I	Tx2n	Transmitter Inverted Data Input	40	CML-I	Tx6n	Transmitter Inverted Data Input
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	41	CML-I	Tx6p	Transmitter Non-Inverted Data Input
4		GND	Ground	42		GND	Ground
5	CML-I	Tx4n	Transmitter Inverted Data Input	43	CML-I	Tx8n	Transmitter Inverted Data Input
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	44	CML-I	Tx8p	Transmitter Non-Inverted Data Input
7		GND	Ground	45		GND	Ground
8	LVTTL-I	ModSelL	Module Select	46		Reserved	
9	LVTTL-I	ResetL	Module Reset	47		VS1	Module Vendor Specific 1
10		VccRx	+ 3.3V Power Supply Receiver	48		VccRx1	3.3V Power Supply
11	LVC MOS-I/O	SCL	2-Wire Serial Interface Clock	49		VS2	Module Vendor Specific 2
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data	50		VS3	Module Vendor Specific 3
13		GND	Ground	51		GND	Ground
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	52	CML-O	Rx7p	Receiver Non-Inverted Data Output
15	CML-O	Rx3n	Receiver Inverted Data Output	53	CML-O	Rx7n	Receiver Inverted Data Output
16		GND	Ground	54		GND	Ground
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	55	CML-O	Rx5p	Receiver Non-Inverted Data Output
18	CML-O	Rx1n	Receiver Inverted Data Output	56	CML-O	Rx5n	Receiver Inverted Data Output
19		GND	Ground	57		GND	Ground
20		GND	Ground	58		GND	Ground
21	CML-O	Rx2n	Receiver Inverted Data Output	59	CML-O	Rx6n	Receiver Inverted Data Output
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	60	CML-O	Rx6p	Receiver Non-Inverted Data Output
23		GND	Ground	61		GND	Ground
24	CML-O	Rx4n	Receiver Inverted Data Output	62	CML-O	Rx8n	Receiver Inverted Data Output
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	63	CML-O	Rx8p	Receiver Non-Inverted Data Output
26		GND	Ground	64		GND	Ground
27	LVTTL-O	ModPrsL	Module Present	65		NC	Not connected
28	LVTTL-O	IntL	Interrupt	66		Reserved	
29		VccTx	+3.3 V Power Supply Transmitter	67		VccTx1	+3.3 V Power Supply
30		Vcc1	+3.3 V Power Supply	68		Vcc2	+3.3 V Power Supply

31	LVTTTL-I	InitMode	Initialization mode	69		Reserved	
32		GND	Ground	70		GND	Ground
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input	71	CML-I	Tx7p	Transmitter Non-Inverted Data Input
34	CML-I	Tx3n	Transmitter Inverted Data Input	72	CML-I	Tx7n	Transmitter Inverted Data Input
35		GND	Ground	73		GND	Ground
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	74	CML-I	Tx5p	Transmitter Non-Inverted Data Input
37	CML-I	Tx1n	Transmitter Inverted Data Input	75	CML-I	Tx5n	Transmitter Inverted Data Input
38		GND	Ground	76		GND	Ground

Recommended QSFP-DD Host Board Schematic

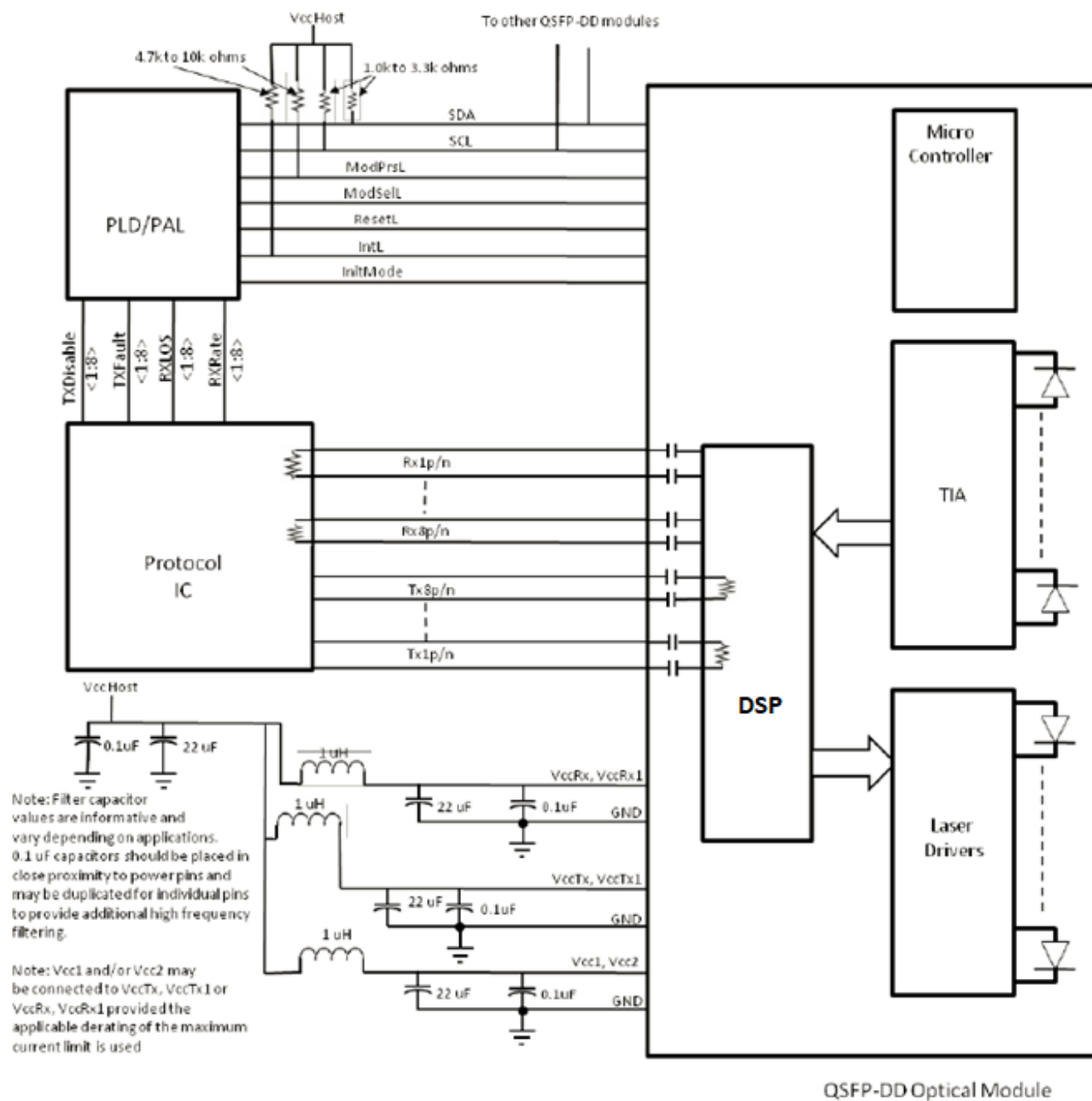


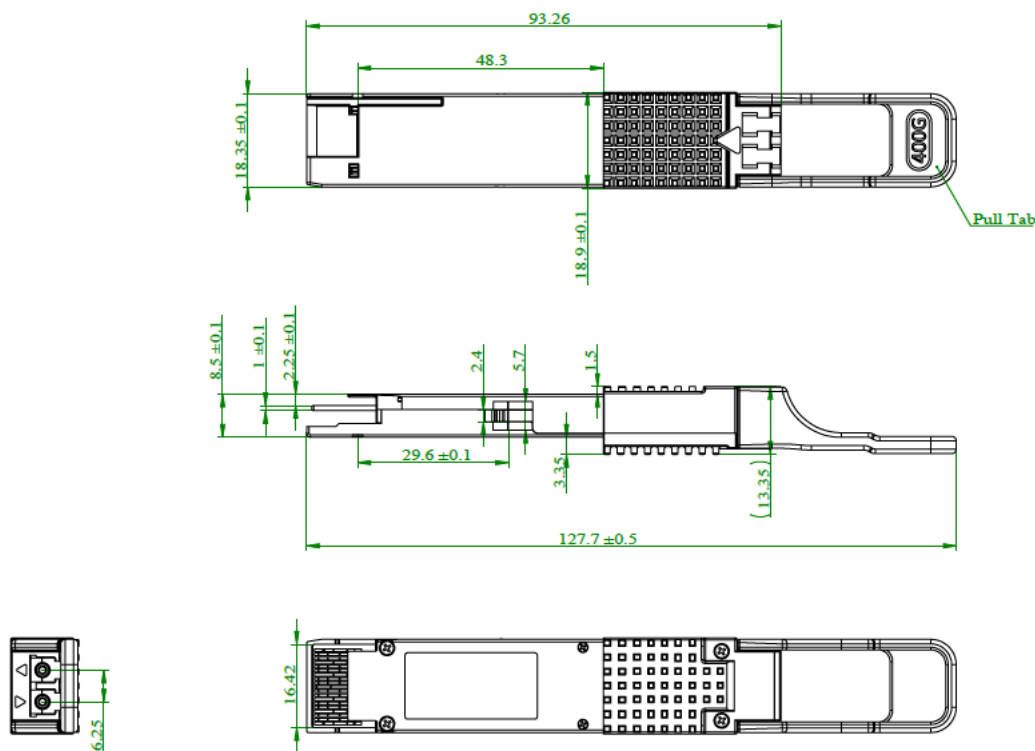
Figure 3 – Recommended QSFP-DD Host Board Schematic

Digital Diagnostics Monitor

Table 8 – Digital Diagnostics

Parameter	Range	Accuracy	Unit	Calibration
Temperature	0 to 70	± 3	°C	Internal
Voltage	3.135 to 3.465	0.1	V	Internal
Tx Bias Current (Each Lane)	0 to 100	10%	mA	Internal
Tx Output Power (Each Lane)	-3.2 to +4.4	± 3	dB	Internal
Rx Receive Power (Each Lane)	-7.2 to +4.4	± 3	dB	Internal

Mechanical Diagram



Ordering information

Table 9 - Ordering Information

Part No.	Application	Data Rate	Laser Source	Fiber Type
AST-4Q2FSF42LC1	400GBASE-FR4	400GB Ethernet	EML	Single Mode Fiber

Warnings

Handling Precautions: This device is susceptible to damage as a result of electrostatic discharge (ESD). A static free environment is highly recommended. Follow guidelines according to proper ESD procedures.

Laser Safety: Class 1 Laser Product. Complies with FDA performance standards for laser products except for conformance with IEC 60825-1 Ed. 3., as described in Laser Notice No. 56, dated May 8, 2019. Radiation emitted by laser devices can be dangerous to human eyes. Avoid eye exposure to direct or indirect radiation.